





ProLight PQ2A-4FxE 4W Power LED Technical Datasheet Version: 1.0

ProLight Opto ® PQ2A Series

Features

•100% foot print compatible with Cree XQ-E •Best Moisture Sensitivity:JEDEC Level 1 •RoHS compliant •Very wide Viewing Angle

Main Applications

Entertainment Lighting
Commercial Lighting
Indoor Lighting
Outdoor Lighting
Stage Lighting
Consumer Portable
Architectural
High-End Portable

Introduction

•ProLight 1616, is one of the smallest high power LED footprint available by ProLight Opto, has offered extended solid-state lighting design possibilities. The 1616's combination of consistent design across all configurations and its small size permit improved color mixing and optical control, compared to the larger 3535 LED. ProLight 1616 is designed with ProLight unique packaging technology which providing high stability reliability.

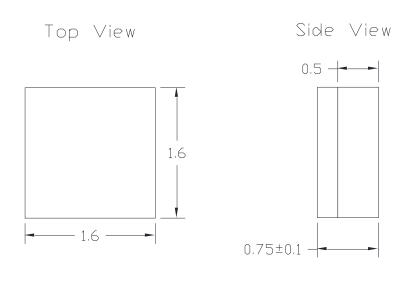
•1616 qualifies as the JEDEC Level 1 MSL sensitivity level and suitable for SMD process, Pb free reflow soldering capability, and full compliance with EU education of Hazardous Substances (RoHS) legislation.

No. 89, Xiyuan Rd., Zhongli City, Taoyuan County 320, Taiwan (R.O.C.) Tel : +886-3-461-8618 Fax : +886-3-461-8677 www.prolightopto.com 2016/10 DS-0624

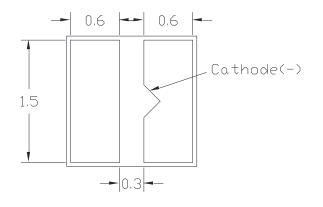
We Provide the Light to the world



Emitter Mechanical Dimensions



Bottom View



Notes:

- 1. Drawing not to scale.
- 2. All dimensions are in millimeters.
- 3. Unless otherwise indicated, tolerances are $\pm\,0.10\text{mm}.$
- 4. Please do not solder the emitter by manual hand soldering, otherwise it will damage the emitter.
- 5. Please do not use a force of over 0.3kgf impact or pressure on the lens of the LED, otherwise it will cause a catastrophic failure.

We Provide the Light to the world



Flux Characteristics, T_J = 25°C

	Part Number		L	uminous I	Flux Φγ (In	n)	
Color	Emitter	@35	0mA	Refer @	2 700mA	Refer @	1000mA
	Emitter	Min.	Тур.	Min.	Тур.	Min.	Тур.
Red	PQ2A-4FRE	30	43	52	75	69	100
Green	PQ2A-4FGE	80	94	117	137	137	161
Blue	PQ2A-4FBE	18.1	30	30.5	48	38.5	63

ProLight maintains a tolerance of ± 7% on flux and power measurements.

• Please do not drive at rated current more than 1 second without proper heat sink.

Electrical Characteristics, T_J = 25°C

		Fo	rward Voltag	ge V _F (V)		Thermal
Color	Min.	@350mA Typ.	Max.	Refer @700mA Typ.	Refer @1000mA Typ.	Resistance Junction to Slug (°C/ W)
00101		iyp.	Max.	iyp.	iyp.	
Red	1.75	2.15	3.00	2.40	2.60	5
Green	2.85	3.10	3.60	3.40	3.60	9
Blue	2.85	3.10	3.60	3.40	3.60	6

ProLight maintains a tolerance of ± 0.1V for Voltage measurements.

Optical Characteristics at 350mA, T_J = 25°C

Radiation Do			Dominant Wavelength λ_D			Viewing Angle (degrees)
Pattern	Color	Min.	Тур.	Max.	θ _{0.90V}	2 θ _{1/2}
	Red	613.5 nm	623 nm	631 nm	160	130
Lambertian	Green	515 nm	525 nm	535 nm	160	130
	Blue	475 nm	480 nm	485 nm	160	130

• ProLight maintains a tolerance of ± 1nm for dominant wavelength measurements.

We Provide the Light to the world



Absolute Maximum Ratings

Parameter	Red/Green/Blue
DC Forward Current (mA)	1000
Peak Pulsed Forward Current (mA)	1500 (less than 1/10 duty cycle@1KHz)
ESD Sensitivity (HBM per MIL-STD-883E Method 3015.7)	±4000V (Class III)
LED Junction Temperature	125°C
Operating Board Temperature at Maximum DC Forward Current	-40°C - 105°C
Storage Temperature	-40°C - 120°C
Soldering Temperature	JEDEC 020c 260°C
Allowable Reflow Cycles	3
Reverse Voltage	Not designed to be driven in reverse bias

Photometric Luminous Flux Bin Structure at 350mA

Color	Bin Code	Minimum Photometric Flux (Im)	Maximum Photometric Flux (Im)	Available Color Bins
Red	Q	30	40	All
	R	40	50	[1]
Green	T2	80	90	All
	U1	90	100	[1]
Blue	N	18.1	23.5	All
	P	23.5	30.6	All
	Q	30.6	39.8	[1]

 \bullet ProLight maintains a tolerance of \pm 7% on flux and power measurements.

• The flux bin of the product may be modified for improvement without notice.

• ^[1] The rest of color bins are not 100% ready for order currently. Please ask for quote and order possibility.

We Provide the Light to the world



Dominant Wavelength Bin Structure

Color	Bin Code	Minimum Dominant Wavelength (nm)	Maximum Dominant Wavelength (nm)
Red	2	613.5	620.5
	4	620.5	631.0
	A	515	520
Orregers	1	520	525
Green	2	525	530
	3	530	535
	4	475	480
Blue	5	480	485

• ProLight maintains a tolerance of ± 1nm for dominant wavelength measurements.

Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.

Forward Voltage Bin Structure at 350mA

Color	Bin Code	Minimum Voltage (V)	Maximum Voltage (V)
	А	1.75	2.00
	В	2.00	2.25
Red	D	2.25	2.50
	E	2.50	2.75
	F	2.75	3.00
	Α	2.85	3.10
Green	В	3.10	3.35
	D	3.35	3.60
	A	2.85	3.10
Blue	В	3.10	3.35
	D	3.35	3.60

• ProLight maintains a tolerance of \pm 0.1V for Voltage measurements.

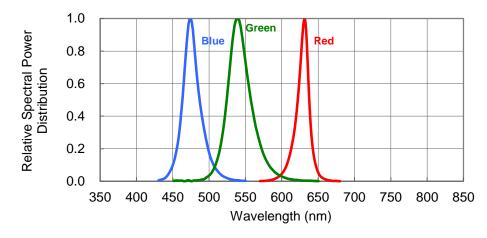
Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.

We Provide the Light to the world



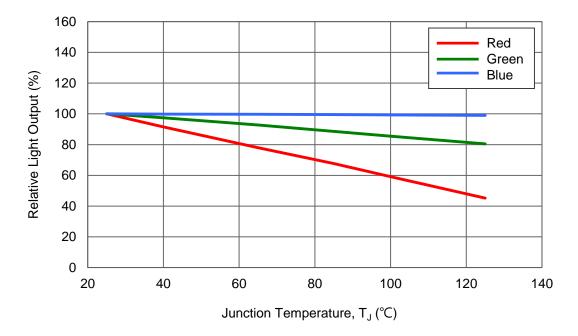
Color Spectrum, T_j = 25°C

1. Blue > Green > Red



Light Output Characteristics

Relative Light Output vs. Junction Temperature at 350mA

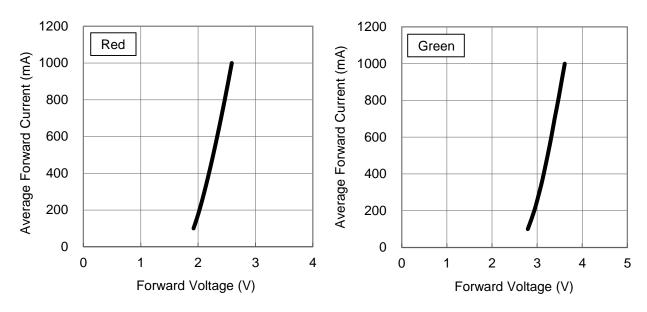


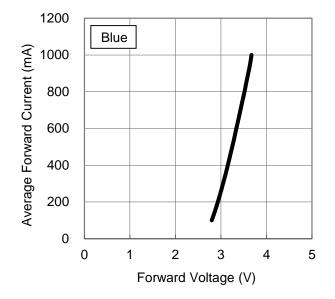
We Provide the Light to the world



Forward Current Characteristics, T_J = 25°C

1. Forward Voltage vs. Forward Current



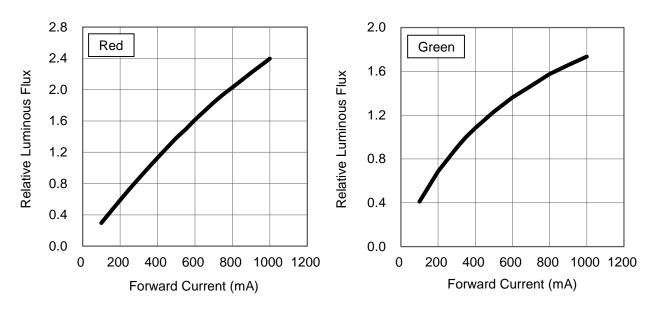


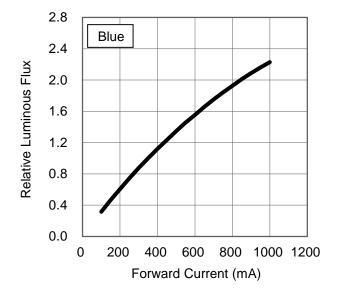
We Provide the Light to the world



Forward Current Characteristics, T_J = 25°C

2. Forward Current vs. Normalized Relative Luminous Flux



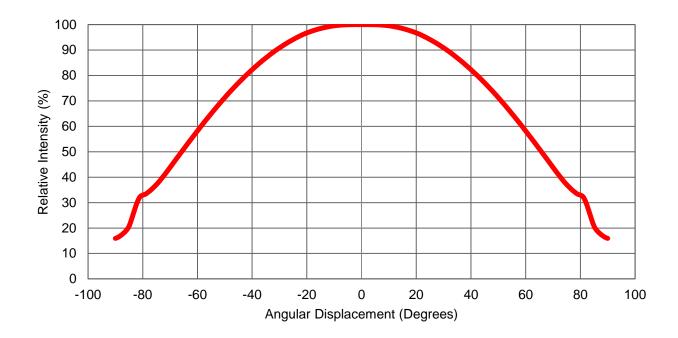


We Provide the Light to the world



Typical Representative Spatial Radiation Pattern

Lambertian Radiation Pattern



We Provide the Light to the world



Moisture Sensitivity Level - JEDEC Level 1

			Soak Requirements			
Level	Floo	r Life	Stan	dard	Accelerated	Environment
	Time	Conditions	Time (hours)	Conditions	Time (hours)	Conditions
1	Unlimited	≤30°C /	168 +5/-0	85°C /	NA	NA
		85% RH		85% RH		

- The standard soak time includes a default value of 24 hours for semiconductor manufature's exposure time (MET) between bake and bag and includes the maximum time allowed out of the bag at the distributor's facility.
- Table below presents the moisture sensitivity level definitions per IPC/JEDEC's J-STD-020C.

				Soak Req	uirements	
Level	Level Floor Life		Stan	dard	Accelerated Environment	
	Time	Conditions	Time (hours)	Conditions	Time (hours)	Conditions
1	Unlimited	≤30°C / 85% RH	168 +5/-0	85°C / 85% RH	NA	NA
2	1 year	≤30°C / 60% RH	168 +5/-0	85°C / 60% RH	NA	NA
2a	4 weeks	≤30°C / 60% RH	696 +5/-0	30°C / 60% RH	120 +1/-0	60°C / 60% RH
3	168 hours	≤30°C / 60% RH	192 +5/-0	30°C / 60% RH	40 +1/-0	60°C / 60% RH
4	72 hours	≤30°C / 60% RH	96 +2/-0	30°C / 60% RH	20 +0.5/-0	60°C / 60% RH
5	48 hours	≤30°C / 60% RH	72 +2/-0	30°C / 60% RH	15 +0.5/-0	60°C / 60% RH
5a	24 hours	≤30°C / 60% RH	48 +2/-0	30°C / 60% RH	10 +0.5/-0	60°C / 60% RH
6	Time on Label (TOL)	≤30°C / 60% RH	Time on Label (TOL)	30°C / 60% RH	NA	NA

We Provide the Light to the world



Qualification Reliability Testing

Stress Test	Stress Conditions	Stress Duration	Failure Criteria
Room Temperature Operating Life (RTOL)	25°C, I _F = max DC (Note 1)	1000 hours	Note 2
Wet High Temperature Operating Life (WHTOL)	85°C/60%RH, I _F = max DC (Note 1)	1000 hours	Note 2
Wet High Temperature Storage Life (WHTSL)	85°C/85%RH, non-operating	1000 hours	Note 2
High Temperature Storage Life (HTSL)	110°C, non-operating	1000 hours	Note 2
Low Temperature Storage Life (LTSL)	-40°C, non-operating	1000 hours	Note 2
Non-operating Temperature Cycle (TMCL)	-40°C to 120°C, 30 min. dwell, <5 min. transfer	200 cycles	Note 2
Mechanical Shock	1500 G, 0.5 msec. pulse, 5 shocks each 6 axis		Note 3
Natural Drop	On concrete from 1.2 m, 3X		Note 3
Variable Vibration Frequency	10-2000-10 Hz, log or linear sweep rate, 20 G about 1 min., 1.5 mm, 3X/axis		Note 3
Solder Heat Resistance (SHR)	260°C ± 5°C, 10 sec.		Note 3
Solderability	Steam age for 16 hrs., then solder dip at 260°C for 5 sec.		Solder coverage on lead

Notes:

1. Depending on the maximum derating curve.

2. Criteria for judging failure

Item	Test Condition	Criteria for Judgement		
llem	Test Condition	Min.	Max.	
Forward Voltage (V _F)	I _F = max DC		Initial Level x 1.1	
Luminous Flux or Radiometric Power (Φ_V)	I _F = max DC	Initial Level x 0.7		
Reverse Current (I _R)	$V_R = 5V$		50 µA	

* The test is performed after the LED is cooled down to the room temperature.

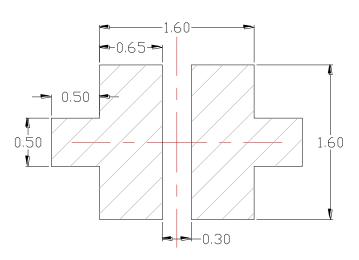
3. A failure is an LED that is open or shorted.

We Provide the Light to the world

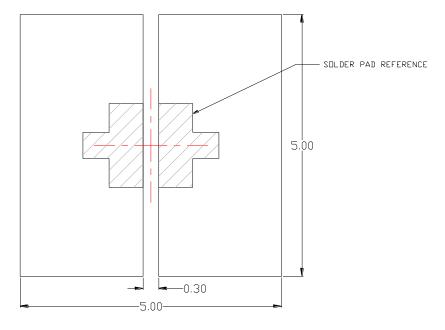


Recommended Solder Pad Design

Recommended PCB solder pad



Recommended trace layout : MCPCB



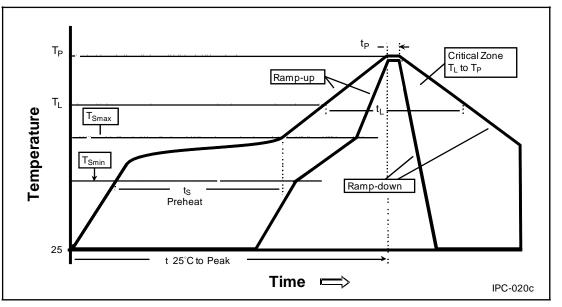
- All dimensions are in millimeters.
- Electrical isolation is required between Slug and Solder Pad.

We Provide the Light to the world



Reflow Soldering Condition

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average Ramp-Up Rate	3°C / second max.	3°C / second max.
(T _{Smax} to T _P)	S C / Second max.	5 C7 second max.
Preheat		
– Temperature Min (T _{Smin})	100°C	150°C
– Temperature Max (T _{Smax})	150°C	200°C
– Time (t _{smin} to t _{smax})	60-120 seconds	60-180 seconds
Time maintained above:		
– Temperature (T _L)	183°C	217°C
– Time (t _L)	60-150 seconds	60-150 seconds
Peak/Classification Temperature (T _P)	240°C	260°C
Time Within 5°C of Actual Peak	10-30 seconds	20-40 seconds
Temperature (t _P)	TO-20 Seconds	20-40 seconds
Ramp-Down Rate	6°C/second max.	6°C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

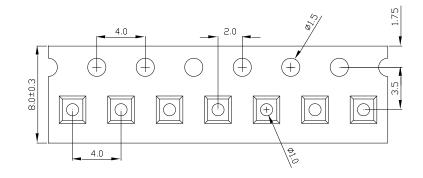


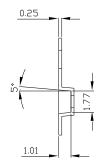
- We recommend using the M705-S101-S4 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.
- Do not use solder pastes with post reflow flux residue>47%. (58Bi-42Sn eutectic alloy, etc) This kind of solder pastes may cause a reliability problem to LED.
- All temperatures refer to topside of the package, measured on the package body surface.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than three times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.

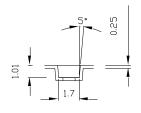
We Provide the Light to the world

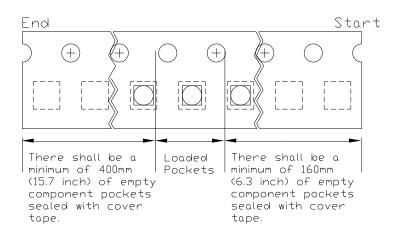


Emitter Reel Packaging









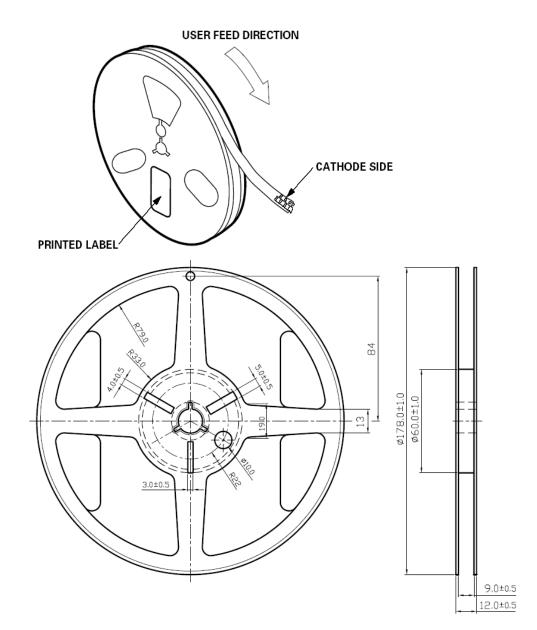
Notes:

- 1. Drawing not to scale.
- 2. All dimensions are in millimeters.
- 3. Unless otherwise indicated, tolerances are \pm 0.10mm.

We Provide the Light to the world



Emitter Reel Packaging



Notes:

- 1. Empty component pockets sealed with top cover tape.
- 2. 2000 pieces per reel.
- 3. Drawing not to scale.
- 4. All dimensions are in millimeters.

We Provide the Light to the world



Precaution for Use

Storage

Please do not open the moisture barrier bag (MBB) more than one week. This may cause the leads of LED discoloration. We recommend storing ProLight's LEDs in a dry box after opening the MBB. The recommended storage conditions are temperature 5 to 30 °C and humidity less than 40% RH. It is also recommended to return the LEDs to the MBB and to reseal the MBB.

- The slug is is not electrically neutral. Therefore, we recommend to isolate the heat sink.
- We recommend using the M705-S101-S4 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.
- Do not use solder pastes with post reflow flux residue>47%. (58Bi-42Sn eutectic alloy, etc) This kind of solder pastes may cause a reliability problem to LED.
- Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temperature after soldering.
- Please avoid rapid cooling after soldering.
- Components should not be mounted on warped direction of PCB.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a heat plate should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When cleaning is required, isopropyl alcohol should be used.
- When the LEDs are illuminating, operating current should be decide after considering the package maximum temperature.
- The appearance, specifications and flux bin of the product may be modified for improvement without notice. Please refer to the below website for the latest datasheets. http://www.prolightopto.com/

Handling of Silicone Lens LEDs

Notes for handling of silicone lens LEDs

- Please do not use a force of over 0.3kgf impact or pressure on the silicone lens, otherwise it will cause a catastrophic failure.
- The LEDs should only be picked up by making contact with the sides of the LED body.
- Avoid touching the silicone lens especially by sharp tools such as Tweezers.
- Avoid leaving fingerprints on the silicone lens.
- Please store the LEDs away from dusty areas or seal the product against dust.
- When populating boards in SMT production, there are basically no restrictions
 regarding the form of the pick and place nozzle, except that mechanical pressure
 on the silicone lens must be prevented.
- Please do not mold over the silicone lens with another resin. (epoxy, urethane, etc)





No. 89, Xiyuan Rd., Zhongli City, Taoyuan County 320, Taiwan (R.O.C.) Tel : +886-3-461-8618 Fax : +886-3-461-8677 www.prolightopto.com

We Provide the Light to the world